

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Martin et al.

Serial No.:

Filed: Herewith

Title: PACKAGE FOR SEALING AN INTEGRATED CIRCUIT DIE

Examiner: Nathan Ha

Art Unit: 2814

Mail Stop Patent Application  
Commissioner for Patents  
PO Box 1450  
Alexandria, VA 22313-1450

**PRELIMINARY AMENDMENT**

Prior to examination and prior to calculating the filing fee, please amend the application as follows:

**Amendments to the Specification** begin on page 2 of this paper.

**Remarks** begin on page 3 of this paper.